74AC11132 QUADRUPLE 2-INPUT POSITIVE-NAND SCHMITT-TRIGGER

SCAS113 - D3482, MARCH 1990 - REVISED APRIL 1993

- Operation From Very Slow Input Transitions
- Temperature-Compensated Threshold Levels
- High Noise Immunity
- Flow-Through Architecture Optimizes PCB Layout
- Center-Pin V_{CC} and GND Configurations Minimize High-Speed Switching Noise
- EPIC™ (Enhanced-Performance Implanted CMOS) 1-µm Process
- 500-mA Typical Latch-Up Immunity at 125°C
- Package Options Include Both Plastic Small-Outline Packages and Standard Plastic 300-mil DIPs

D OR N PACKAGE (TOP VIEW)							
1A [1Y [2Y [GND [GND [3Y [4Y [1 2 3 4 5 6 7 8	16 15 14 13 12 11 10 9	1B 2A 2B V _{CC} V _{CC} 3A 3B 4A				

description

Each circuit functions as a NAND gate, but because of the Schmitt action, it has different input threshold levels for positive- and negative-going signals. It performs the Boolean function $Y = \overline{A} \cdot \overline{B}$ or $Y = \overline{A} + \overline{B}$ in positive logic.

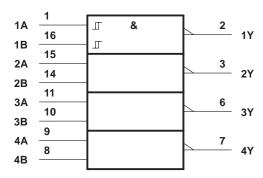
These circuits are temperature compensated and can be triggered from the slowest of input ramps and still give clean jitter-free output signals.

The 74AC11132 is characterized for operation from -40° C to 85° C.

FUNCTION TABLE

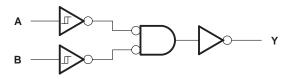
INP	UTS	OUTPUT
Α	В	Y
Н	Н	L
L	Χ	Н
Х	L	Н

logic symbol†



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}	– 0.5 V to 7 V
Input voltage range, V _I (see Note 1)	$-0.5 \text{ V to V}_{CC} + 0.5 \text{ V}$
Output voltage range, V _O (see Note 1)	$-0.5 \text{ V to V}_{CC} + 0.5 \text{ V}$
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$)	± 20 mA
Output clamp current, I _{OK} (V _O < 0 or V _O > V _{CC})	± 50 mA
Continuous output current, $I_O(V_O = 0 \text{ to } V_{CC})$	± 50 mA
Continuous current through V _{CC} or GND	± 100 mA
Storage temperature range	

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

recommended operating conditions

			MIN	NOM	MAX	UNIT
Vcc	Supply voltage		3	5	5.5	V
		V _{CC} = 3 V	2.2			
VIH	High-level input voltage	V _{CC} = 4.5 V	3.2			V
		V _{CC} = 5.5 V	3.9			
		V _{CC} = 3 V			0.5	
V _{IL} Low-level input voltage	Low-level input voltage	V _{CC} = 4.5 V			0.9	mA
		V _{CC} = 5.5 V			1.1	
VI	Input voltage				- 24	mA
VO	Output voltage				- 24	IIIA
		V _{CC} = 3 V	0		VCC	
lOH	High-level output current	V _{CC} = 4.5 V	0		VCC	V
		V _{CC} = 5.5 V			-4	
	Low-level output current	V _{CC} = 3 V			12	
IOL		V _{CC} = 4.5 V			24	mA
		V _{CC} = 5.5 V			24	24
Δt/Δν	Input transition rise or fall rate		0		100	ns/V
T _A	Operating free-air temperature		- 40		85	°C

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	Vaa	T,	_Δ = 25°C		MIN MAX	UNIT	
PARAMETER	TEST CONDITIONS	Vcc	MIN	TYP	MAX	IVIIIV	IVIAA	UNIT
		3 V			2.2		2.2	
V _{T+}		4.5 V			3.2		3.2	V
		5.5 V			3.9		3.9	
		3 V	0.5			0.5		
V _T		4.5 V	0.9			0.9		V
		5.5 V	1.1			1.1		
V		3 V	0.3		1.2	0.3	1.2	
V _{hys} (V _{T+} – V _{T-})		4.5 V	0.4		1.4	0.4	1.4	V
(14 1-)		5.5 V	0.5		1.6	0.5	1.6	
	ΙΟΗ = - 50 μΑ	3 V	2.9			2.9		
		4.5 V	4.4			4.4		
		5.5 V	5.4			5.4		
Voн	$I_{OH} = -4 \text{ mA}$	3 V	2.58			2.48		V
	I _{OH} = -24 mA	4.5 V	3.94			3.8		
		5.5 V	4.94			4.8		
	$I_{OH} = -75 \text{ mA}^{\dagger}$	5.5 V				3.85		
		3 V			0.1		0.1	
	I _{OL} = 50 μA	4.5 V			0.1		0.1	
		5.5 V			0.1		0.1	
V_{OL}	$I_{OL} = 12 \text{ mA}$	3 V			0.36		0.44	V
	I _{OL} = 24 mA	4.5 V			0.36		0.44	
	10L = 2 · · · · · ·	5.5 V			0.36		0.44	
	$I_{OL} = 75 \text{ mA}^{\dagger}$	5.5 V					1.65	
Ι _Ι	$V_I = V_{CC}$ or GND	5.5 V			± 0.1		± 1	μΑ
Icc	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			4		40	μΑ
Ci	$V_I = V_{CC}$ or GND	5 V		3.5				pF

T Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.

switching characteristics over recommended operating free-air temperature range, V_{CC} = 3.3 V \pm 0.3 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	T _A = 25°C			MIN MAX	UNIT	
PARAIVIETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	IVIIIV	IVIAA	UNIT
t _{PLH}	A or B	V	2.2	6.2	9.2	2.2	10.3	no
^t PHL	AUID	ī	2.8	6.8	9.8	2.8	10.5	ns

switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	T _A = 25°C			MIN MAX	MAX	UNIT
PARAWETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	IVIIIV	WAX	UNIT
t _{PLH}	A or B	V	1.8	4.2	6.9	1.8	7.5	20
t _{PHL}	AUID	ī	2.3	4.8	7.3	2.3	8	ns

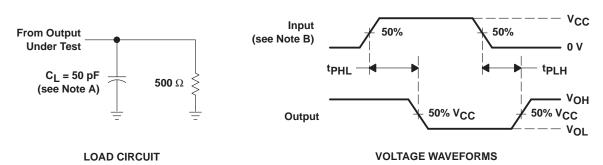


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operating characteristics, V_{CC} = 5 V, T_A = 25°C

	PARAMETER	TEST CONDITIONS	TYP	UNIT
C _{pd}	Power dissipation capacitance	$C_L = 50 \text{ pF}, \qquad f = 1 \text{ MHz}$	27	pF

PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. Input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$, $t_f = 3 \text{ ns}$, $t_f = 3 \text{ ns}$.
- C. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms





ti.com 23-Apr-2005

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
74AC11132D	OBSOLETE	SOIC	D	16	TBD	Call TI	Call TI
74AC11132N	OBSOLETE	PDIP	N	16	TBD	Call TI	Call TI
74AC11132N	OBSOLETE	PDIP	N	16	TBD	Call TI	Call TI

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

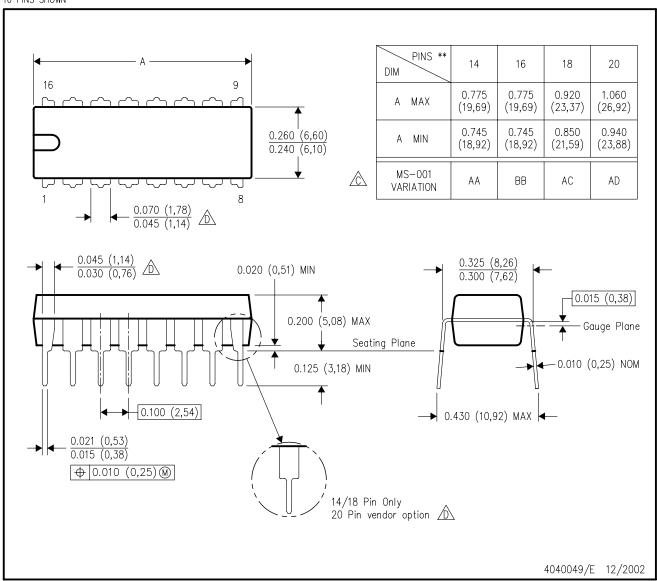
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N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



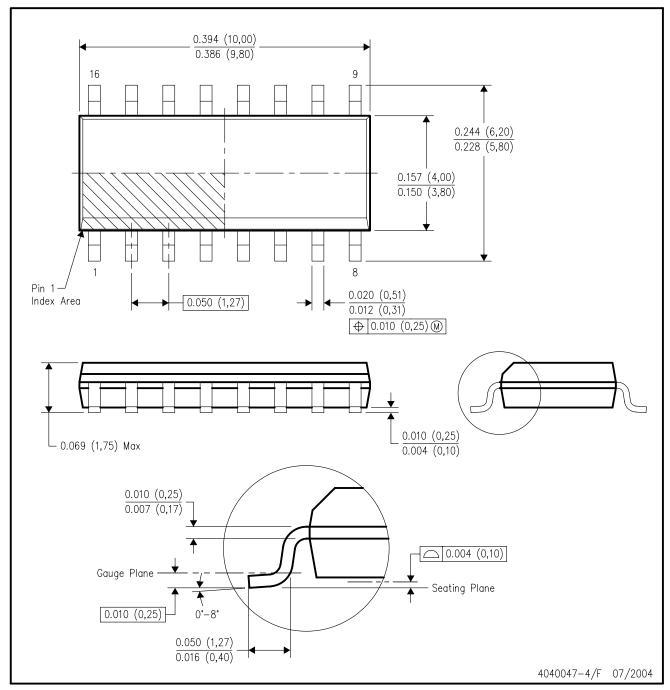
NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



D (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012 variation AC.



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